

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
100V	3.9mΩ@10V	130A

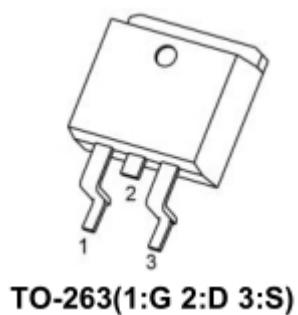
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

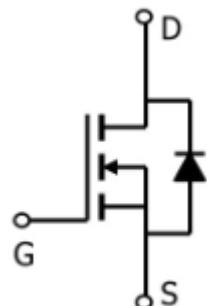
Application

- Power switching application
- DC-DC Converter
- Power Management

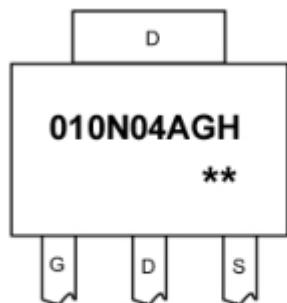
Package



Circuit diagram



Marking



010N04AGH : Product code
** : Week code

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_c = 25^\circ\text{C}$)	I_D	130	A
Pulsed Drain Current	I_{DM}	520	A
Total Power Dissipation($T_c = 25^\circ\text{C}$)	P_D	210	W
Single Pulse Avalanche Energy ¹	E_{AS}	180	mJ
Thermal Resistance Junction-Case	$R_{\theta JC}$	0.59	$^\circ\text{C}/\text{W}$
Operation and storage temperature	T_{STG}, T_J	-55~ +150	$^\circ\text{C}$

Electrical characteristics

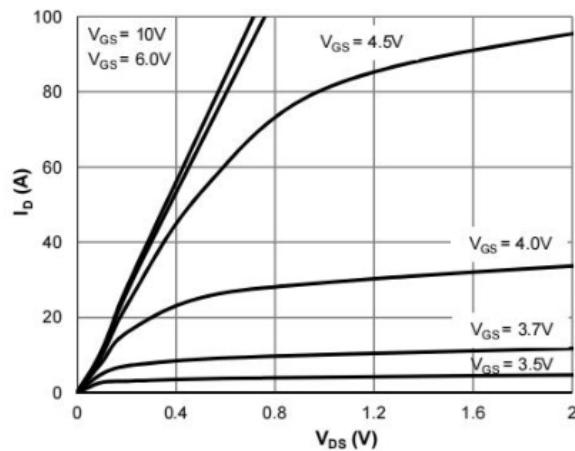
($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 0.1	μA
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2	3	4	V
Static Drain-Source on-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$		3.9	5.2	Ω
Dynamic characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 50\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		6750		pF
Output Capacitance	C_{oss}			650		
Reverse Transfer Capacitance	C_{rss}			46		
Switching Characteristics						
Total Gate Charge	Q_g	$V_{\text{DS}} = 50\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 50\text{A}$		100		nC
Gate-Source Charge	Q_{gs}			43		
Gate-Drain Charge	Q_{gd}			19		
Turn-On Delay Time	$T_{\text{d}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, V_{\text{DS}} = 50\text{V}, I_D = 50\text{A}, R_G = 3.0\Omega$		20		nS
Rise Time	T_r			70		
Turn-Off Delay Time	$T_{\text{d}(\text{off})}$			50		
Fall Time	T_f			16		
Diode Characteristics						
Diode Forward Voltage2	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = 1\text{A}$			1.2	V

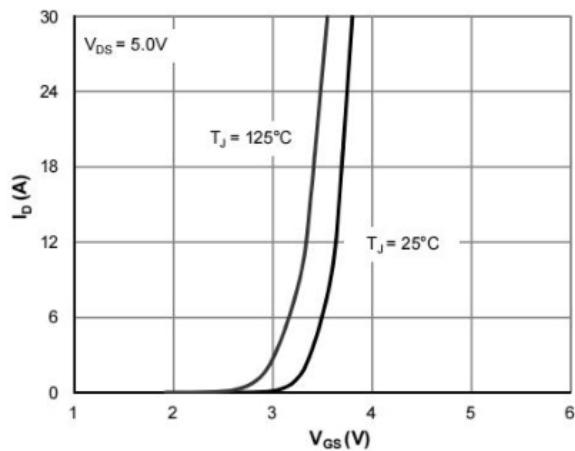
Notes:

- E AS is tested at starting $T_j = 25^\circ\text{C}$, $V_{\text{DD}} = 50\text{V}, V_{\text{GS}} = 10\text{V}, L = 0.1\text{mH}, R_g = 25\text{m}\Omega, I_{\text{AS}} = 65\text{A}$;

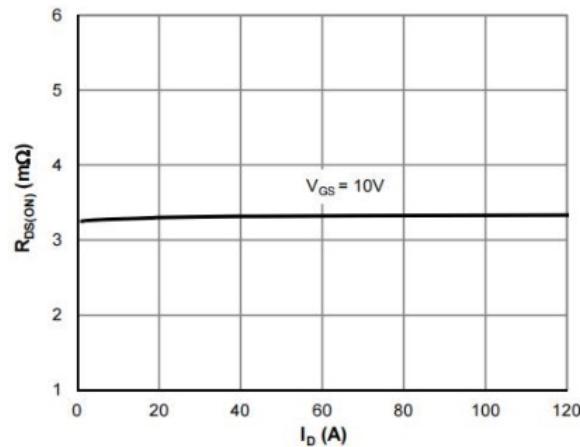
Typical Characteristics



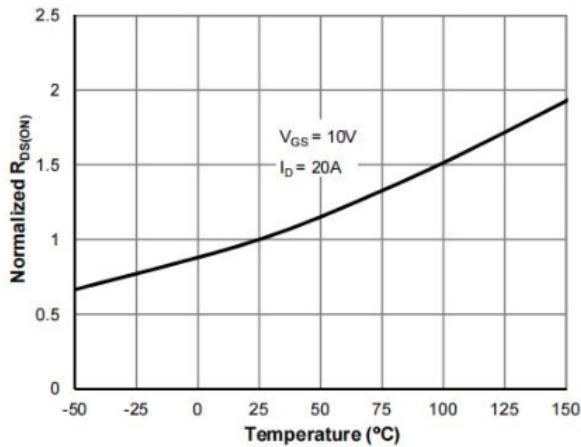
Typical Output Characteristics



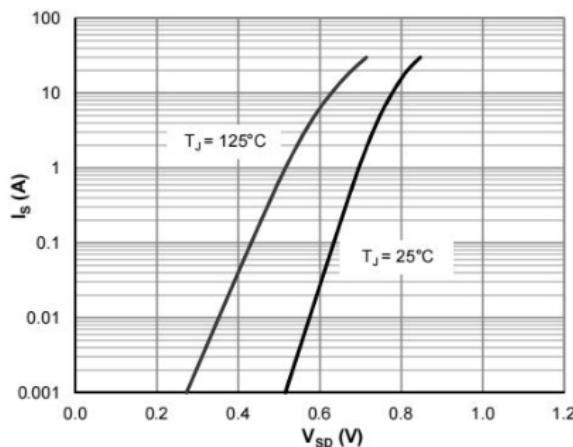
Transfer Characteristics



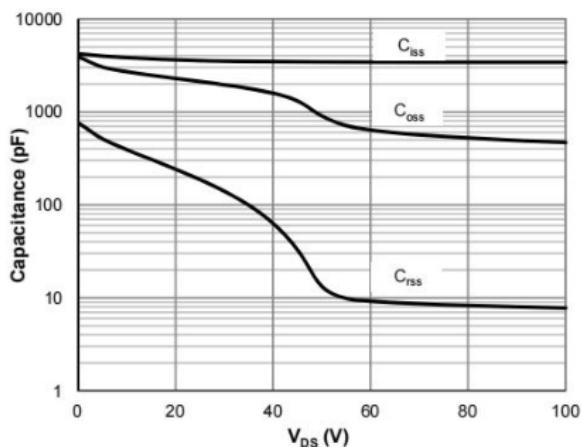
On-Resistance vs. Drain Current



On-Resistance vs. Junction Temperature



Body-Diode Characteristics

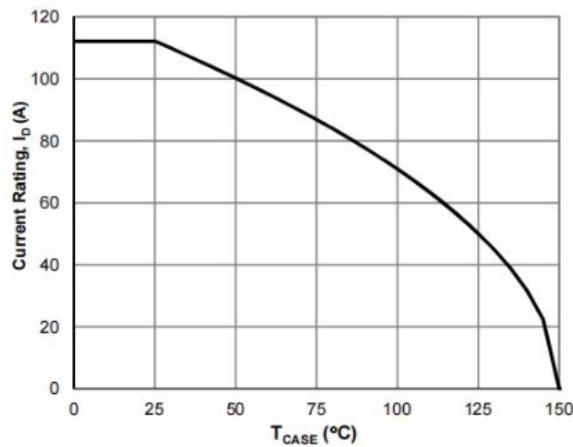


Capacitance Characteristics

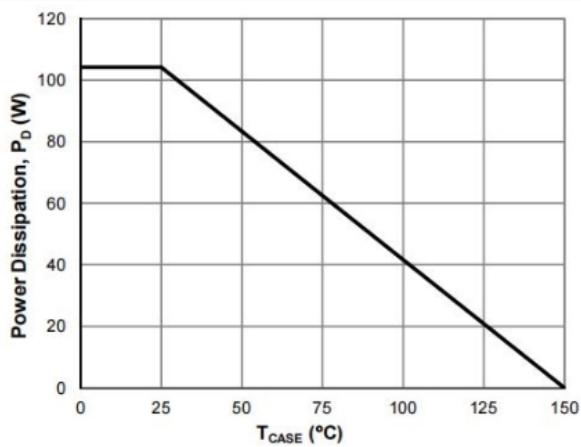


ZL MOSFET

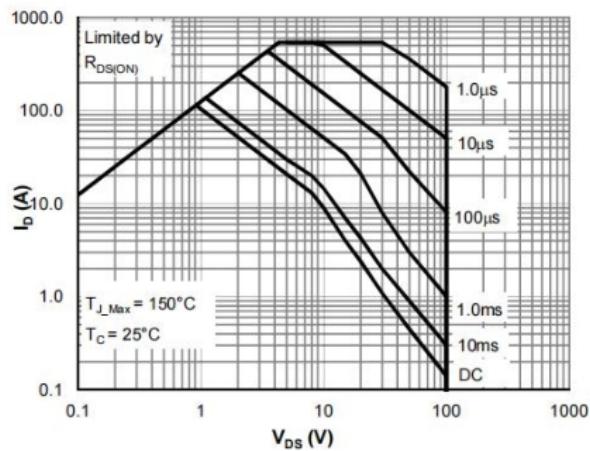
ZL010N04AGH



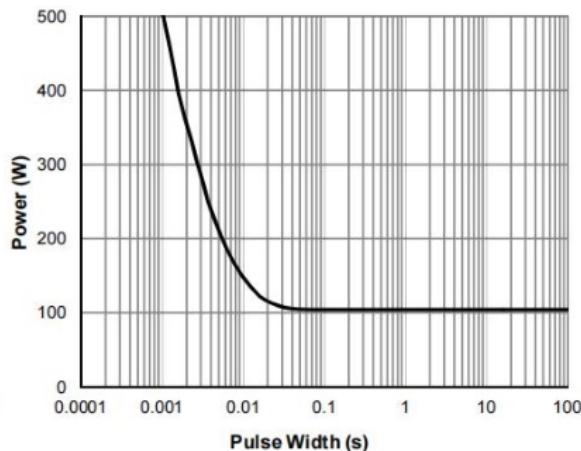
Current De-rating



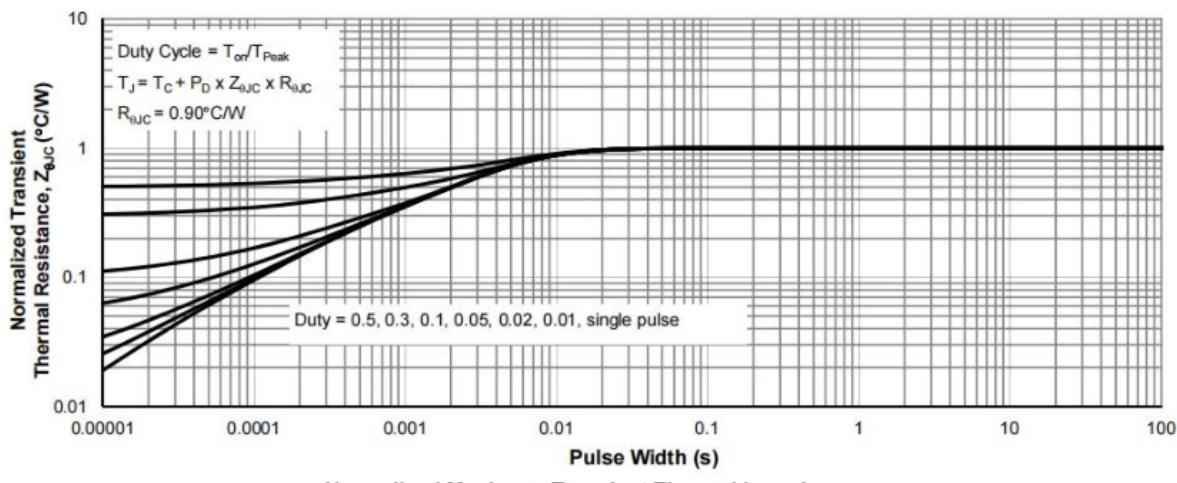
Power De-rating



Maximum Safe Operating Area

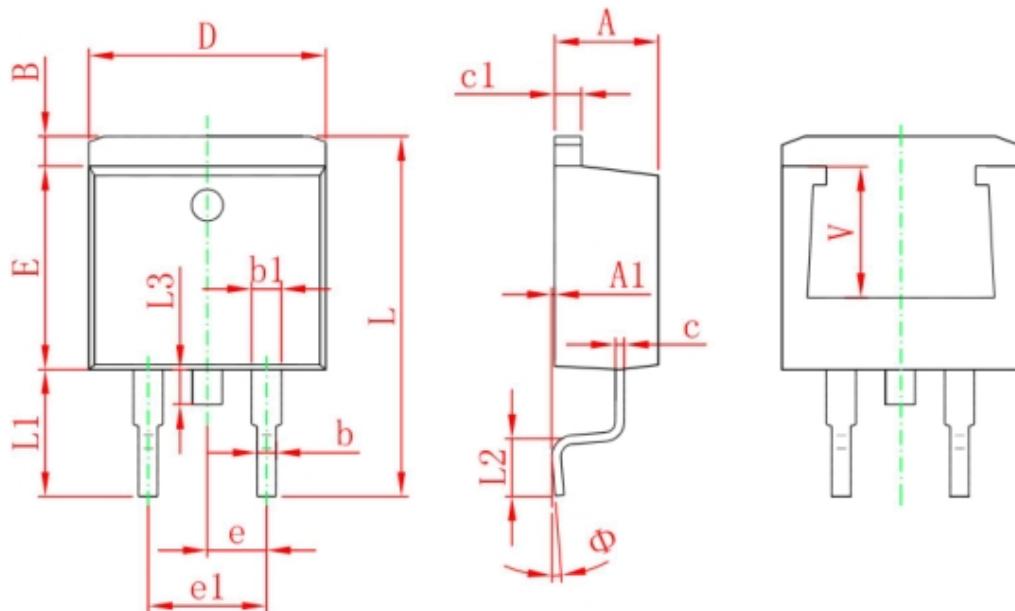


Single Pulse Power Rating, Junction-to-Case



Normalized Maximum Transient Thermal Impedance

TO-263 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.120	1.420	0.044	0.056
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	14.940	15.500	0.588	0.610
L1	4.950	5.450	0.195	0.215
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
Φ	0°	8°	0°	8°
V	5.600 REF.		0.220 REF.	